

TLE8263EXUMA3 Information


For Reference Only

Part Number [TLE8263EXUMA3](#)
Manufacturer Infineon Technologies
Category Integrated Circuits (ICs)
[Specialized ICs](#)
Description IC SYSTEM BASIS CHIP DSO-36
Package 36-BSSOP (0.295", 7.50mm Width) Exposed Pad
 For the pricing/inventory/lead time, please contact us
 Website: <https://www.heisener.com>
 E-mail: salesdept@heisener.com


[Request a Quote](#)
Certified Quality

Heisener's commitment to quality has shaped our processes for sourcing, testing, shipping, and every step in between. This foundation underlies each component we sell.


TLE8263EXUMA3 Specifications

Manufacturer Part Number	TLE8263EXUMA3
Manufacturer	Infineon Technologies
Category	Integrated Circuits (ICs) Specialized ICs
Package	36-BSSOP (0.295", 7.50mm Width) Exposed Pad
Series	*
Type	-
Applications	-
Mounting Type	Surface Mount
Package / Case	36-BSSOP (0.295", 7.50mm Width) Exposed Pad
Supplier Device Package	PG-DSO-36
Report errors?	

TLE8263EXUMA3 Guarantees

Quality Guarantees

We provide 90 days warranty. *

If the items you received were not in perfect quality, we would be responsible for your refund or replacement, but the items must be returned in their original condition.


Service Guarantees

We guarantee 100% customer satisfaction.

Our experienced sales team and tech support team back our services to satisfy all our customers.

TLE8263EXUMA3 Payment Methods



TLE8263EXUMA3 Shipping Methods



If you have any question about TLE8263EXUMA3, please do not hesitate to contact us!

Website: <https://www.heisener.com>

E-mail: salesdept@heisener.com